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XPort®
AR ARCHITECT
Integration Guide

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Revision History

Date	Rev.	Comments
June 2005	A	Initial Release
March 2007	B	Correct pin numbers
June 2006	C	Updated figure 2-7, and identified Pin 1; corrected references to CP12 & CP13
June 2010	D	Minor corrections. Update company contact info.
September 2010	E	Minor corrections. Updated schematics under heading "Recommended PCB Layout".
May 2011	F	Updated figures 2-1, 2-6, 2-7 and 2-8.
June 2011	G	Updated figures 2-7 and 2-8.
October 2011	H	Updated security information.

For the latest revision of this product document, please check our online documentation at www.lantronix.com/support/documentation.

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1: Introduction

About the Integration Guide

This guide provides the information needed to test the XPort[®] AR device server on the XPort AR Evaluation Board. This manual is intended for engineers responsible for integrating the XPort AR into their product.

Additional Documentation

For supporting product documentation, or the most current version of this document, please visit the Lantronix Web site at www.lantronix.com/support/documentation.

Document	Description
<i>XPort AR Getting Started</i>	Provides the steps for getting the hardware and software up and running.
<i>XPort AR User Guide</i>	Provides information needed to configure, use, and update the XPort firmware.
<i>XPort AR Command Reference</i>	Lists and explains XPort AR command line and XML commands.
<i>Com Port Redirector User Guide</i>	Provides information on using the Windows-based utility to create a virtual com port.

2: Description and Specifications

The XPort AR embedded device server is a complete network-enabling solution enclosed within an RJ45 package. This miniature device server empowers original equipment manufacturers (OEMs) to quickly and easily go to market with networking and web page serving capabilities built into their products.

The XPort AR

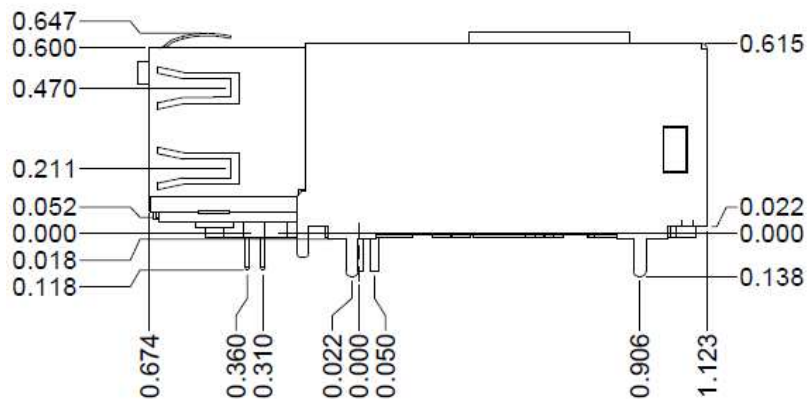
The XPort AR contains Lantronix's own DSTni controller, with 256 Kbytes of SRAM, 16 Kbytes of boot ROM, and integrated AMD 10/100 PHY.

The XPort AR also contains the following:

- ◆ New powerful operating system with additional new features.
- ◆ Two full serial ports with all hardware handshaking signals (or three serial ports without handshaking signals).
- ◆ 13 pins are configurable as general purpose I/O.
- ◆ Supports fully compliant Power over Ethernet (PoE) designs by using PoE compliant magnetics and passing through both the used and unused pairs.
- ◆ Memory: 4 MB Flash and 1.25 MB RAM.
- ◆ 3.3-volt serial interface.
- ◆ All I/O pins are 5V tolerant.
- ◆ Ethernet magnetics.
- ◆ Power supply filters.
- ◆ Reset circuit.
- ◆ +1.8V regulator.
- ◆ Ethernet LEDs.

The XPort AR requires +3.3-volt power and is designed to operate over an industrial temperature range (see technical data).

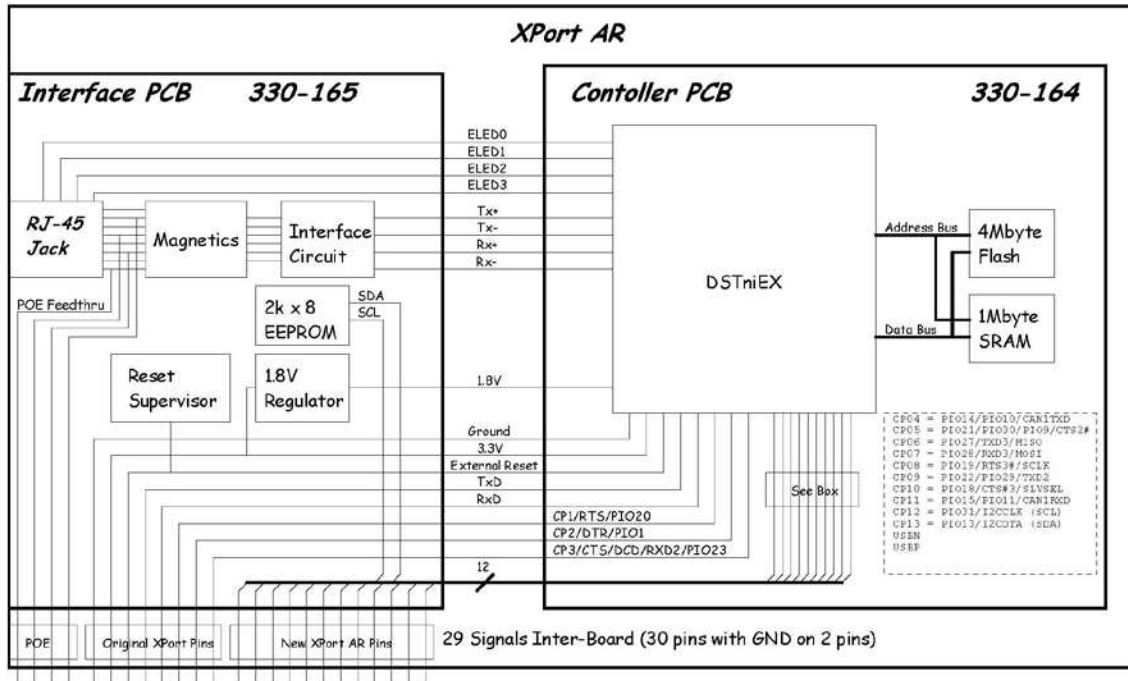
Figure 2-1. Side View of the XPort AR



XPort AR Block Diagram

The following drawing is a block diagram of the XPort AR showing the relationships of the components.

Figure 2-2. XPort AR Block Diagram



PCB Interface

Standard Pins (Evaluation Board XP300200K-01)

The XPort AR has 26 electrical pins. There are 20 pins that form two rows of ten. These 20 pins form the standard interface between the XPort AR and the circuit in which it is installed. These include dedicated serial as well as 11 programmable I/O pins (Configurable Pins, or CPs). The other group of six pins is for PoE.

The standard signals are 3.3V CMOS logic level but are 5V tolerant. These signals are typically connected to internal devices, such as a relays, sensors, or UARTs. For prototype and evaluation work or applications where an external RS-232 interface is required, RS-232 transceivers are available on the XPort AR evaluation board. Optionally, disconnect them using the jumpers provided if they are not needed.

Note: Typically, after booting up CP pins are in an unstable state for a few seconds. However, the state of the CP pins in the XPort-AR is initially high-impedance, suitable for an input. To use a CP pin as an output, the pin may be biased high or low with a resistor to +V or ground so it will be "defined" as either 1 or 0 during this initial time.

Table 2-1. Standard Interface Signals

Signal Name	XPort AR Pin #	Primary Functions
GND	4	Signal Ground
VCC	5	+3.3V Power In
Reset	8	External Reset In
TXDA	9	Serial Data Out, Channel A
RXDA	12	Serial Data In, Channel A
CP01	13	Programmable I/O or RTSA flow control
CP02	16	Programmable I/O or DTRA flow control
CP03	17	Programmable I/O or CTSA flow control
CP04	3	Programmable I/O or DSRA flow control
CP05	7	Programmable I/O or DCDA flow control
CP06	2	Programmable I/O or TXDB flow control
CP07	10	Programmable I/O or RXDB flow control
CP08	1	Programmable I/O or RTSB flow control
CP09	6	Programmable I/O or DTRB flow control
CP10	20	Programmable I/O or CTSB flow control
CP11	19	Programmable I/O or DSRB/DCDB flow control
CP12	11	I ² C clock
CP13	14	I ² C data
Reserved	15	Reserved
Reserved	18	Reserved

PoE Pins

XPort AR is PoE-ready; it allows a fully compliant PoE circuit to be implemented that uses the Ethernet signals entering the XPort AR's RJ-45 jack. When the XPort AR's RJ-45 jack is connected to a PoE compliant switch, pins 21, 22, 25, and 26 pass through the necessary Ethernet signals to allow a PoE powered-device circuit to negotiate and receive power from the switch.

Table 2-2. PoE Interface Signals

Signal Name	XPort R Pin #	Primary Functions
POE12	22	Center tap from 1 & 2
POE36	25	Center tap from 3 & 6
POE45	21	Ethernet pins 4 & 5
POE78	26	Ethernet pins 7 & 8
CHSGND	23	Chassis Ground

Signal Name	XPort R Pin #	Primary Functions
CHSGND	24	Chassis Ground

Note: The four shield tabs are also Chassis Ground. Separate Chassis Ground appropriately from the Signal Ground and route so as to safely dissipate electrostatic discharge.

Ethernet Interface

The RJ-45 connector, Ethernet magnetics, PHY and Ethernet status LEDs are all integrated into the XPort AR.

Table 2-3. Ethernet Interface Signals

Signal Name	DIR	Contact	Primary Function	Note
TX+	Out	1	Differential Ethernet Transmit Data +	Magnetics center tap provides signal POE12
TX-	Out	2	Differential Ethernet Transmit Data -	
RX+	In	3	Differential Ethernet Receive Data +	Magnetics center tap provides signal POE36
RX-	In	6	Differential Ethernet Receive Data -	
Not Used		4	(Terminated)	Pins 4 and 5 are tied together, terminated and form POE45
Not Used		5	(Terminated)	
Not Used		7	(Terminated)	Pins 7 and 8 are tied together, terminated and form POE78
Not Used		8	(Terminated)	
CHSGND		Shield	Chassis Ground	

Reset

The XPort AR reset pin is an input-only pin and connects to an 811-type reset IC. Internal to the 811 is a 20k pull-up. This is the only influence the XPort AR has on the reset pin. This input is intended for a push-button switch type manual reset. If no external reset control is desired, leave this pin floating.

LEDs

The XPort AR contains the following LEDs:

- ◆ Link (bi-color, left LED)
- ◆ Activity (bi-color, right LED)

Figure 2-3. XPort AR LEDs

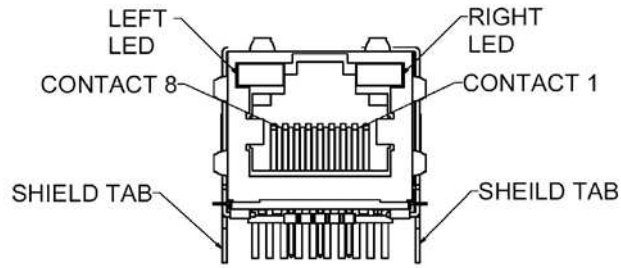


Table 2-4. XPort AR LED Functions

Link LED Left Side		Activity LED Right Side	
Color	Meaning	Color	Meaning
Off	No Link	Off	No Activity
Amber	10 Mbps	Amber	Half Duplex
Green	100 Mbps	Green	Full Duplex

Dimensions

The XPort AR dimensions are shown in the following illustrations:

Figure 2-4. Front View

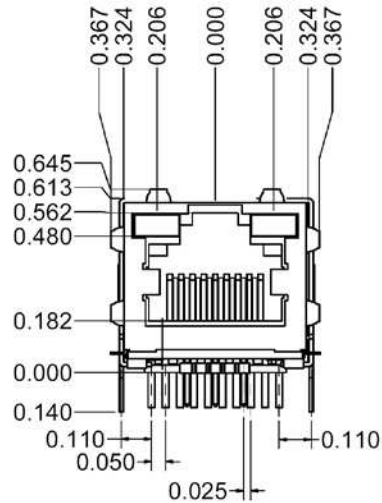


Figure 2-5. Bottom View

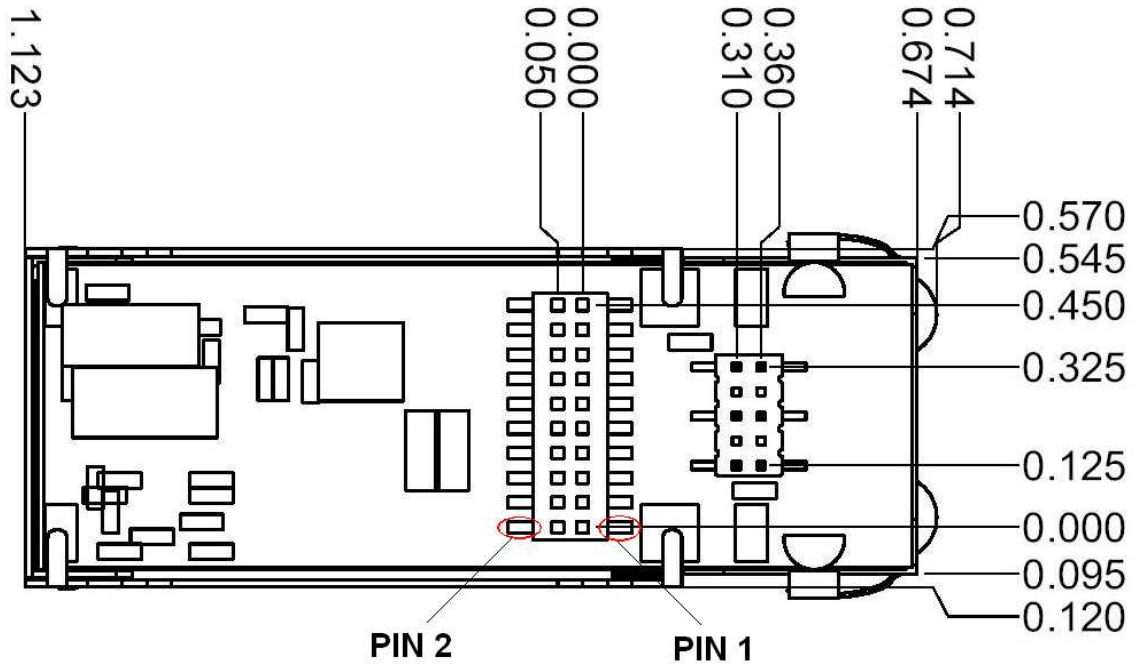
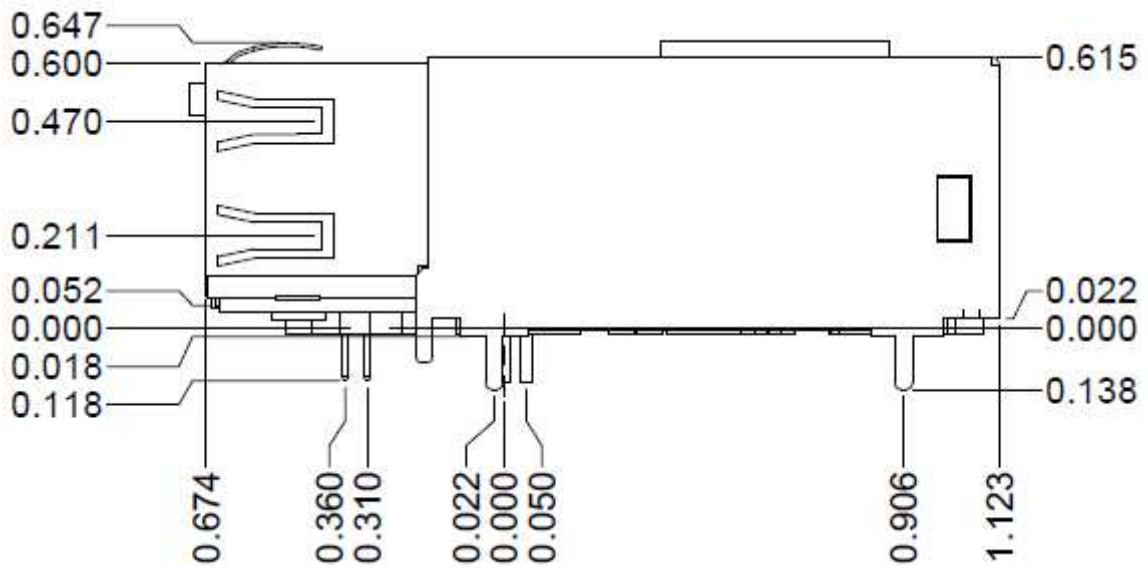


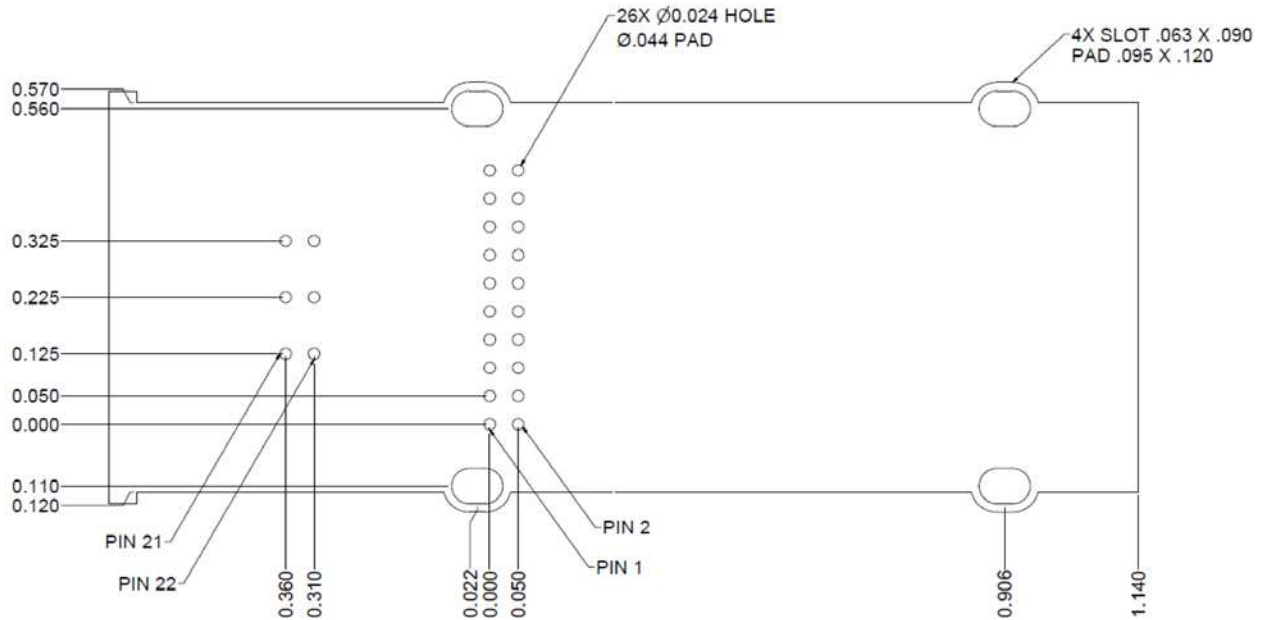
Figure 2-6. Side View



Recommended PCB Layout

The hole pattern and mounting dimensions for the XPort AR are shown in the following illustration. For proper heat dissipation, it is recommended that the PCB have approximately 1 square inch of copper attached to the shield tabs. The shield tabs are an important source of heat sinking for the device.

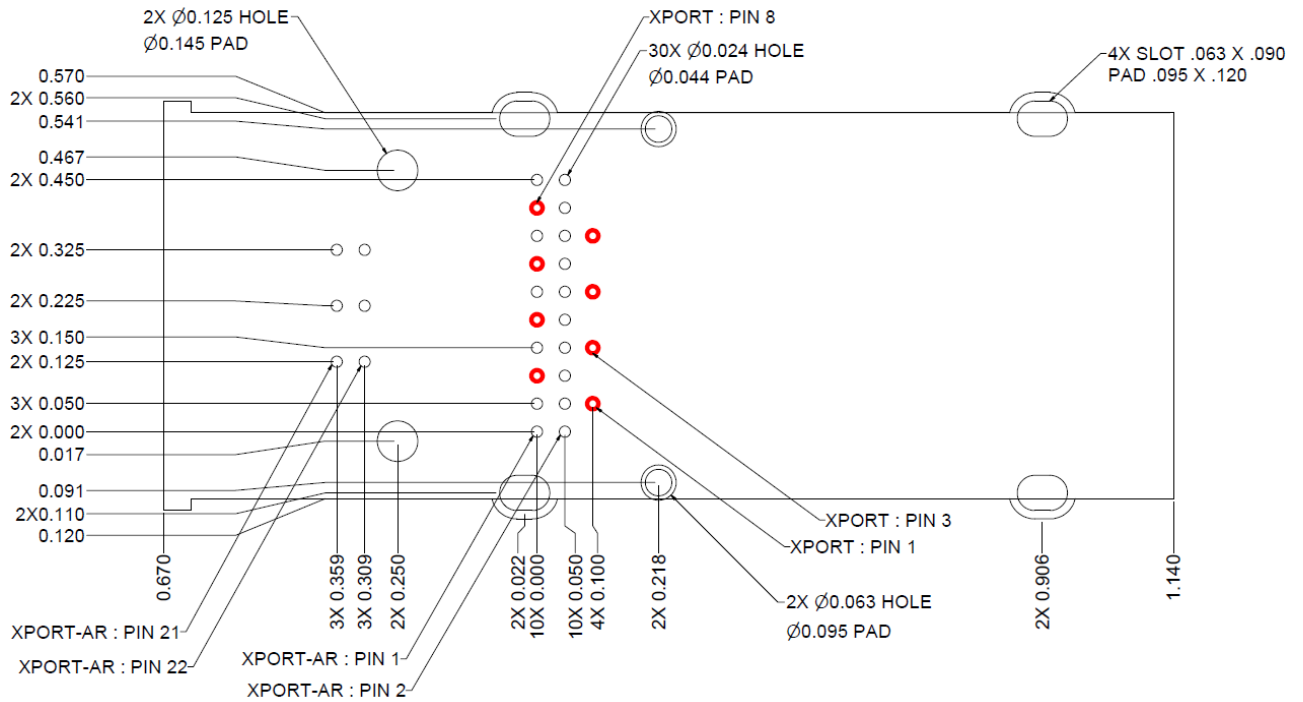
Figure 2-7. PCB Layout (Top View)



XPort Compatibility

The XPort AR is designed for the PCB layout to accommodate either an XPort AR or the original Lantronix XPort. To accomplish this, a few extra holes are required. The hole pattern and mounting dimensions for this combination XPort/XPort AR footprint are shown in the following drawing:

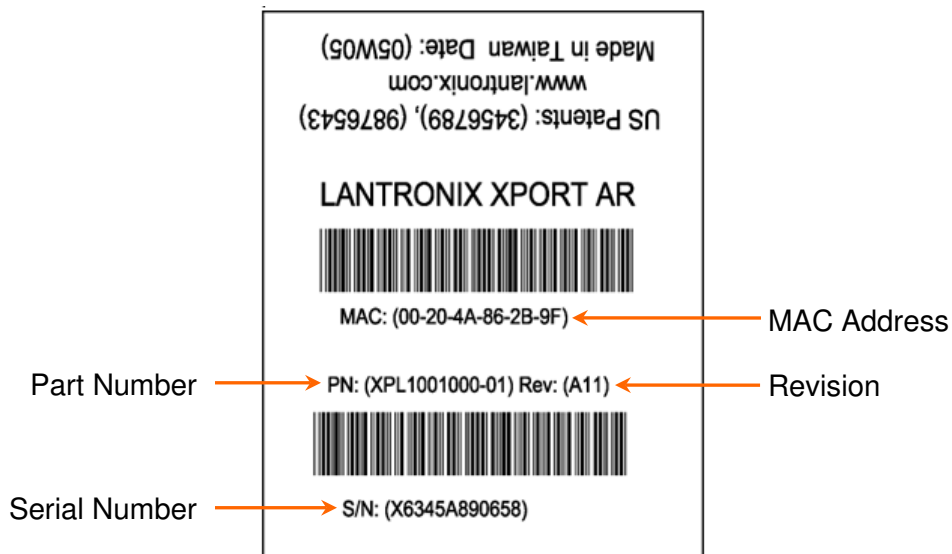
Figure 2-8. Hole Pattern and Mounting Dimensions (Bottom View)



Product Information Label

The product information label contains important information about your specific unit, such as its product ID (name), bar code, part number, serial number, and Ethernet (MAC) address.

Figure 2-9. Product Label



Technical Specifications

Table 2-5. Technical Specifications

Category	Description
CPU	Lantronix DSTni-EX 186 CPU with 256 kB zero wait state SRAM, 512 kB flash, 16 kB boot ROM
Memory	<ul style="list-style-type: none"> • 2 KB EEPROM • 1 MB 70ns SRAM • 4 MB 70ns Flash
Reset Circuit	Internal 350ms (± 200 ms) reset pulse. Triggered by power-on, power drop-out or external reset input. Power drop-out reset triggered at 2.93V (range: 2.79-3.00V)
Serial Interface	CMOS (Asynchronous) 3.3V-level signals Rate is software selectable: 300 bps up to 230400 bps (depending on the software)
Serial Line Formats	Data bits: 7 or 8 Stop bits: 1 or 2 Parity: odd, even, none
Modem Control	RTS, DTR, CTS, DSR, DCD
Flow Control	XON/XOFF (software), CTS/RTS (hardware), None
Programmable I/O	13 PIOs (software selectable), sink minimum of 4.4mA, source minimum of 6.4mA
Network Interface	RJ45 Ethernet 10Base-T or 100Base-TX (auto-sensing)
Compliance	Ethernet: Version 2.0/IEEE 802.3 (electrical) Ethernet II frame type IEEE 802.3af (when PoE-enabled)
Protocols Supported	ARP, UDP/IP, TCP/IP, Telnet, ICMP, SNMP, DHCP, BOOTP, TFTP, Auto IP, SMTP, and HTTP
LEDs	10Base-T and 100Base-TX Link Full/half duplex activity
Management	Internal web server, SNMP (read only) Serial login, Telnet login, XML
Email	SMTP client: can send email to multiple users, can attach files to email Configurable Pins (CPs) can trigger emails
Security	SSL v2, SSH v3, AES 128-bit encryption, password protection, IP address filtering, locking features, hardened OS and stack
Internal Web Server	Servers static and dynamic CGI-based pages Storage capacity: 1.3 MB using industry standard filesystem
Material	Metal shell, thermoplastic case
Temperature	Operating range: -40°C to +85°C (-40°F to 185°F)
Shock/Vibration	Non-operational shock: 500 g's Non-operational vibration: 20 g's
Warranty	Two year limited warranty
Included Software	Windows™ -based DeviceInstaller configuration software and Windows™-based Com Port Redirector

3: Evaluation Kit

The XPort AR Evaluation Kit includes everything needed to integrate XPort AR into a product design.

Contents of the Kit

The evaluation kit contains the following items:

- ◆ XPort AR Evaluation Board
- ◆ XPort AR Device Server
- ◆ +3.3VDC Universal Power Supply
- ◆ CAT5e UTP RJ45M/M Ethernet cable
- ◆ .025" square-post jumper wires
- ◆ RS-232 cable, DE-9, F/F
- ◆ CD with software utilities and documentation (in PDF format)

Evaluation Board Description

The XPort AR Evaluation Board provides many features for evaluating the Lantronix XPort AR embedded device server. These features allow both quick start-up for immediate interaction with the XPort AR and its operating system, as well as a prototyping area and easy access to all signals for evaluating advanced features.

Major Features

The major features of the evaluation board include:

- ◆ Headers offering:
 - ◆ All 18 signals of the XPort AR interface.
 - ◆ Monitoring LEDs to jumper to XPort AR Configurable Pins (CPs).
 - ◆ Input control switches to jumper to XPort AR CPs.
 - ◆ Pull-up resistors to jumper to XPort AR CPs.
 - ◆ Signal ground (GND) to jumper to XPort AR CPs.
- ◆ Prototyping Area:
 - ◆ 258 holes on 100 mil centers.
 - ◆ Every header pin is also connected to the adjacent prototyping hole.
 - ◆ 8 power and 8 ground holes are available for powering prototype circuits.
- ◆ LEDs:
 - ◆ Power (Blue).
 - ◆ Tx (Green) & Rx (Yellow) activity for both ports A and B.
 - ◆ Four available to jumper to CPs for monitoring.
- ◆ Power:
 - ◆ 3.3V input with power switch.
 - ◆ PoE socket containing all signals necessary to receive power over Ethernet and return 3.3V to the board.
- ◆ Serial Ports:
 - ◆ Two DE-9 male connectors
 - ◆ Transceivers can be disconnected from XPort AR by jumper removal (if not used).
- ◆ Switches:

- ◆ Power on/off.
- ◆ Push button reset.
- ◆ Two available to jumper to CPs for generating input.
- ◆ Ground:
 - ◆ Turret available for scope probe alligator clip connection to signal ground.
- ◆ XPort AR Footprint:
 - ◆ Accommodates both XPort AR and the original XPort (without sockets).

Evaluation Board Major Components

Figure 3-1. Evaluation Board

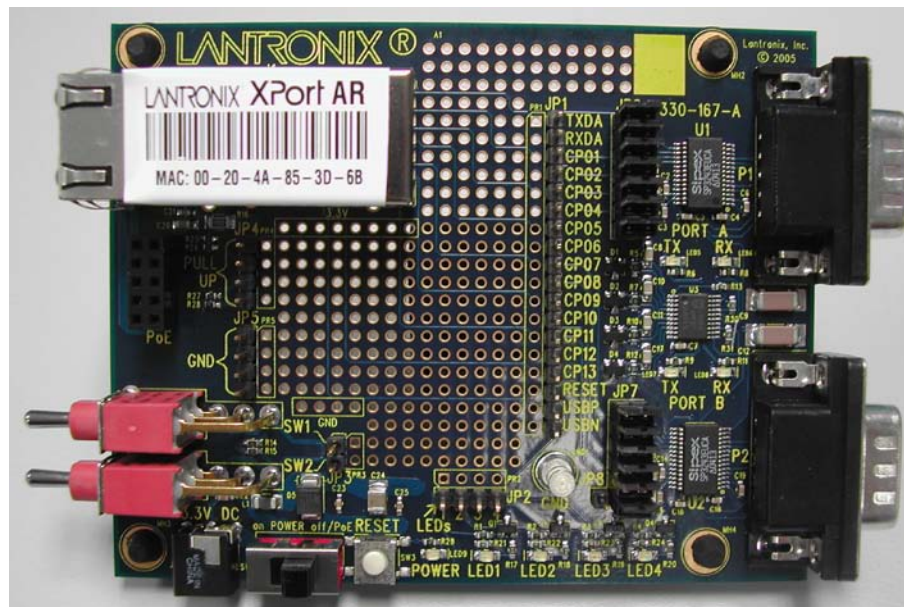
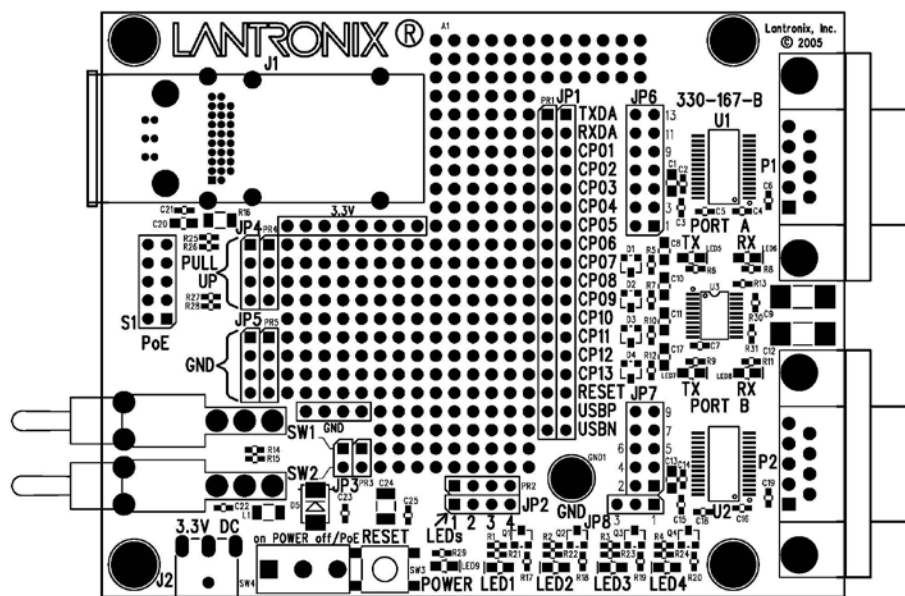


Figure 3-2. Evaluation Board (Diagram)



Major Components

The major components of the evaluation board include:

- ◆ XPort AR
- ◆ Power Switch
- ◆ Reset Switch
- ◆ Headers
- ◆ Disconnect Jumpers
- ◆ LEDs
- ◆ Test Switches
- ◆ Prototyping Area
- ◆ RS-232 Serial Ports
- ◆ PoE Socket
- ◆ Ground Turret
- ◆ Power Input Connector

XPort AR

The XPort AR is placed in the upper left corner of the evaluation board and is referenced as J1.

Note: The footprint used for J1 on the evaluation board is compatible with both the XPort AR and the original Lantronix XPort.

Power Switch

The two positions of the power switch are On and Off/PoE. In the On position, the evaluation board gets its power from the 3.3 VDC input jack. In the Off/PoE position, the evaluation board uses 3.3 VDC from the PoE socket S1 (if a circuit is attached that makes it available). This provides a convenient On/Off switch in either case.

Reset Switch

The reset switch grounds the reset pin on the XPort AR. The XPort AR reset pin is an input-only pin and connects to an 811-type reset IC. Internal to the 811 is a 20k pull-up and is the only influence the XPort AR has on the reset pin.

Headers

The headers provide access to all of the XPort AR signals, as well as to circuits for I/O control and monitoring.

JP1: Signal Access Header

This header provides access to each XPort AR signal. Use these pins to monitor activity with an oscilloscope or to jumper to one of the four monitoring LEDs. When a CP is configured as an input, it can be connected with a jumper to GND, a pull-up, or switch with pull-up and switchable ground contact.

Note: Typically, after booting up CP pins are in an unstable state for a few seconds. However, the state of the CP pins in the XPort-AR is initially high-impedance, suitable for an input. To use a CP pin as an output, the pin may be biased high or low with a resistor to +V or ground so it will be "defined" as either 1 or 0 during this initial time.

Table 3-1. JP1 Connections

JP1 Pin #	Connects To:
1	TXDA
2	RXDA
3	CP01 (RTSA)
4	CP02 (DTRA)
5	CP03 (CTSA)
6	CP04 (DSRA)
7	CP05 (DCDA)
8	CP06 (TXDB)
9	CP07 (RXDB)
10	CP08 (RTSB)
11	CP09 (DTRB)
12	CP10 (CTSB)
13	CP11 (DSRB)
14	CP12 (I2CCLK)
15	CP13 (I2CDTA)
16	RESET
17	Reserved
18	Reserved

JP2: LED Header

This header provides access to each of the monitoring LEDs. These pins can be connected with a jumper wire to any of the JP1 pins to monitor the signal level with the corresponding LED. When a high is present, the LED illuminates. Test LEDs by using a jumper to any of the JP4 pull-up pins. Each LED has a unique color to facilitate identifying the LEDs that are on.

Table 3-2. JP2 Connections

JP2 Pin #	Connects To:
1	LED1 – green
2	LED2 – yellow
3	LED3 – orange
4	LED4 – red

JP3: Input Switch Header

This header provides access to each of the two input control switches. These pins can be connected with a jumper wire to any of the JP1 pins to control the signal level with the corresponding switch. When a switch is in the center position, it is off. This allows a 1K pull-up resistor to create a high on the corresponding pin. When a switch is turned on, it connects the corresponding pin to ground. Each switch has a latched-on down position and a momentary-on up position

Table 3-3. JP3 Connections

JP3 Pin #	Connects To:
1	Switch 1
2	Switch 2

JP4: Pull-Up Header

This header provides access to 1k pull-up resistors. These pins can be connected with a jumper wire to any of the JP1 pins to set the signal level to high (in cases where the corresponding CP is configured as an input). Use the JP3 switched signals for signals that you wish to change between high and low relatively often.

Table 3-4. JP4 Connections

JP4 Pin #	Connects To:
1	1k pull-up resistor
2	1k pull-up resistor
3	1k pull-up resistor
4	1k pull-up resistor

JP5: GND Header

This header provides access to signal ground. These pins can be connected with a jumper wire to any of the JP1 pins to set the signal level to low (in cases where the corresponding CP is configured as an input). For signals that you wish to change between high and low relatively often, use the JP3 switched signals.

Table 3-5. JP5 Connections

JP5 Pin #	Connects To:
1	Signal ground (GND)
2	Signal ground (GND)
3	Signal ground (GND)
4	Signal ground (GND)

Disconnect Jumpers

JP6: Disconnect Jumper Header

This header provides jumper positions to connect the XPort AR to the RS-232 Port A transceiver when an RS-232 serial interface is desired. Install any number/combination of these jumpers, depending on which RS-232 signals are required and which XPort AR signals are to perform functions other than RS-232 related.

Table 3-6. JP6 Connections

JP6 Pin #	Connects To:	JP6 Pin #	Connects To:
1	RS-232 XCVR, TXDA Input	2	XPort AR, TXDA
3	RS-232 XCVR, RTSA Input	4	XPort AR, CP01
5	RS-232 XCVR, DTRA Input	6	XPort AR, CP02
7	RS-232 XCVR, RXDA Output	8	XPort AR, RXDA
9	RS-232 XCVR, CTSA Output	10	XPort AR, CP03
11	RS-232 XCVR, DSRA Output	12	XPort AR, CP04
13	RS-232 XCVR, DCDA Output	14	XPort AR, CP05

JP7: Disconnect Jumper Header

This header provides jumper positions to connect the XPort AR to the RS-232 Port B transceiver when this RS-232 serial interface is desired. Any number/combination of these jumpers may be installed depending on which RS-232 signals are required and which XPort AR signals are to perform functions other than RS-232 related.

Table 3-7. JP7 Connections

JP7 Pin #	Connects To:	JP7 Pin #	Connects To:
1	RS-232 XCVR, TXDB Input	2	XPort AR, CP06
3	RS-232 XCVR, RTSB Input	4	XPort AR, CP08
5	RS-232 XCVR, DTRB Input	6	XPort AR, CP09
7	RS-232 XCVR, RXDB Output	8	XPort AR, CP07
9	RS-232 XCVR, CTSB Output	10	XPort AR, CP10

JP8: Disconnect Jumper Header

This header provides jumper positions to connect the XPort AR to the RS-232 Port B transceiver when this RS-232 serial interface is desired and requires either DSR or DCD. Since CP12 and CP13 are dedicated to an I²C function, only CP11 remains to serve both DSR and DCD on port B. This jumper has two positions: 1-2 or 2-3. In the 1-2 position, it connects the XPort AR signal CP11 to the DSR output for Port B. In the 2-3 position, it connects the XPort AR signal CP11 to the DCD output for Port B. This choice is made based on whether the serial interface intends to use DSR or DCD.

Table 3-8. JP8 Connections

JP8 Pin #	Connects To:
1	RS-232 XCVR, DSRB Output
2	XPort AR, CP11
3	RS-232 XCVR, DCDB Output

LEDs

The LEDs on the XPort AR evaluation board provide indications of power on, RS-232 port activity, and states of selected signals.

LED1 – LED4: Signal Monitoring LEDs

These LEDs are used to monitor the state of selected XPort AR signals. A signal selected for monitoring is connected to an LED by placing a jumper wire between the signal's pin in header JP1 and an LED control pin in header JP2. These LEDs are driven by transistors. As such, there is very little load placed on the observed signal. This allows the LEDs to be used to observe a signal in a prototype circuit without affecting the circuit's behavior.

LED5 – LED8: RS-232 Activity Monitoring LEDs

These LEDs are used to monitor activity on the RS-232 ports. These LEDs are driven by a circuit that detects a low level on the transmit signals or receive signals and generates a minimum length drive signal to the LEDs of a few hundred milliseconds. Since RS-232 signals are high when data is not transmitted, these LEDs are off when there is no activity.

***Note:** These LEDs can be used as additional signal state monitors when the RS-232 transceivers are not being used. To accomplish this, jumper the signals to be monitored to JP6-p1, JP6-p7, JP7-p1, JP7-p7.*

LED9: Power LEDs

This blue LED illuminates any time the evaluation board is powered.

Test Switches

The test switches, SW1 and SW2 generate switchable high/low input signals to XPort AR CPs that are configured for input. These are 3- position switches (on, off, and momentary). When a switch is in the center position (off), it allows a pull-up resistor to create a high on the corresponding header pin. When a switch is turned on, it connects its corresponding header pin to ground. Each switch has a latched-on down position and a momentary-on up position. These switchable signals are connected to the desired CP pin with jumpers placed between JP3 and JP1.

Prototyping Area

The prototyping area provides 258 holes on 0.100" centers for addition of prototype circuitry to the XPort AR evaluation board. Most of the holes are floating and available for any added component lead to be placed in them. A few holes are pre-connected for convenience and neatness of the circuit to be prototyped. These pre-connected holes have a thin-line silkscreen border around them. These bordered groups of pre-connected holes are marked with the reference designators PR1-PR5, GND and 3.3V.

PR1 is the group of holes adjacent to header JP1. Each hole in PR1 is connected to the adjacent JP1 pin. When prototype circuitry is to be connected to an XPort AR signal, solder a wire between the appropriate PR1 hole and the appropriate prototype circuit lead (or place the prototype component's lead directly in the PR1 hole). This keeps the JP1 pins available for jumpers to LEDs or switches.

PR2 provides the same type of convenient connections to the observation LEDs for use in prototype circuits.

Similarly, PR3 provides connections to SW1 and SW2.

PR4 is the group of holes adjacent to the pull-up header, JP4. Each of the four holes is connected to the adjacent pin on JP4. A separate 1k pull-up resistor is connected to each of these holes/pins. These are available for use as needed in a prototype circuit.

The four holes grouped as PR5 and the four holes grouped as GND (lower left corner of prototyping area) are all directly connected to the signal ground plane of the evaluation board. These eight holes provide good signal ground connections for prototype circuitry.

The eight holes grouped as 3.3V provide direct connection to the 3.3V power plane of the evaluation board. These eight holes provide good power plane connections for prototype circuitry.

RS-232 Serial Interfaces

The RS-232 serial interfaces are implemented with transceivers that convert 3.3V CMOS levels to RS-232 levels. A null-modem serial cable with 9-pin connectors (F/F) is the only item needed to connect to another DTE device such as a PC.

The table below lists the RS-232 signals.

Note: All XPort AR serial interface signal pins, except 9 and 12, are CPs that can be optionally set for functions other than their RS-232 function.

The jumpers in JP6, JP7, and JP8 determine whether or not the XPort AR pins are connected to the RS-232 transceivers. When using RS-232, the signals used must have their associated jumper installed in JP6, JP7, and JP8.

Table 3-9. RS-232 Signals

Signal	XPort AR				PC
	Pin #	Jumper	Direction	DE-9 Pin #	Connection
DCDA (CP05)	7	JP6, 13-14	In	P1-1	--
RXDA	12	JP6, 7-8	In	P1-2	TXD
TXDA	9	JP6, 1-2	Out	P1-3	RXD
DTRA (CP02)	16	JP6, 5-5	Out	P1-4	DSR
GND	4	--	--	P1-5	GND
DSRA (CP04)	3	JP6, 11-12	In	P1-6	DTR
RTSA (CP01)	13	JP6, 3-4	Out	P1-7	CTS
CTSA (CP03)	17	JP6, 9-10	In	P1-8	RTS
--	--	--	--	P1-9	--
DCDB (CP11)	19	JP8, 3-2	In	P2-1	--
RXDB (CP07)	10	JP7, 7-8	In	P2-2	TXD
TXDB (CP06)	2	JP7, 1-2	Out	P2-3	RXD
DTRB (CP09)	6	JP7, 5-6	Out	P2-4	DSR
GND	4	--	--	P2-5	GND
DSRB (CP11)	19	JP8, 1-2	In	P2-6	DTR
RTSB (CP08)	1	JP7, 3-4	Out	P2-7	CTS
CTSB (CP10)	20	JP7, 9-10	In	P2-8	RTS
--	--	--	--	P2-9	--

PoE Socket

The PoE Socket (Samtec: SSQ-105-01-G-D; Oupiin: 2044-2 X 5 G S; Molex: 15-44-3205) provides access to both the used pairs and unused pairs from the Ethernet. It provides connection to the evaluation board's 3.3V power switch, signal ground, and chassis ground. The socket's pinouts are:

- ◆ Pin 1, PoE45: Ethernet signals 4 and 5. (These two Ethernet pins are connected together inside the XPort AR and exit out of this pin.)
- ◆ Pin 2, PoE12: Ethernet signals 1 and 2. (This pin comes from the center tap of the XPort AR's PoE compliant magnetics connected to the Ethernet pins 1 and 2.)
- ◆ Pins 3 & 4, 3V3PoE: Connect to the evaluation board's power switch.
- ◆ Pins 5 & 6: Connect to the evaluation board's chassis ground. (Connection is optional.)
- ◆ Pins 7 & 8, GND: Connect to the evaluation board's signal ground.
- ◆ Pin 9, PoE36: Ethernet signals 3 and 6. (This pin comes from the center tap of the XPort AR's PoE compliant magnetics that are connected to Ethernet pins 3 and 6.)
- ◆ Pin 10, PoE78: Ethernet signals 7 and 8. (These two Ethernet pins are connected together inside the XPort AR and exit out of this pin.)

Ground Turret

The turret marked GND (lower right corner of prototyping area) is a convenient way to connect an oscilloscope or DMM ground clip to signal ground. This type of ground connection has proven to be a much more secure way to keep an alligator-type clip in place. For smaller clip leads, the pins of JP5 are also connected to signal ground.

Power Supply

The evaluation board typically uses 3.3 VDC regulated input power entering through a 1.3 mm input power jack. It is possible to power the board from 3.3 VDC input to the PoE socket, S1; this is usually only performed in combination with an external PoE circuit also connected to S1. The evaluation kit provides a 3.3 VDC 1.3 mm power module.

It is recommend that chassis ground of the evaluation board be connected to an earth ground. Chassis ground on the evaluation board is found at the four mounting holes, the D-connector shells, and the XPort AR shell.

Schematic

The XPort AR evaluation board schematic shows the relationships of all of the previously described components.